PROJEK DEVICES

SMDA03LC thru SMDA24LCC

LOW CAPACITANCE TVS ARRAY

APPLICATIONS

- ✓ SCSI & IDE Interfaces
- ✔ Parallel & Serial Port Protection (RS-232)
- ✓ Ethernet 10/100 Base T
- ✓ Test & Measurement Equipment
- ✓ Industrial Control: Low Voltage Sensors

IEC COMPATIBILITY (EN61000-4)

- ✓ 61000-4-4 (EFT): 40A 5/50ns
- ✓ 61000-4-5 (Surge): 12A, 8/20µs Level 1(Line-Gnd) & Level 2(Line-Line)

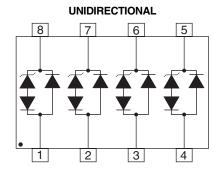
FEATURES

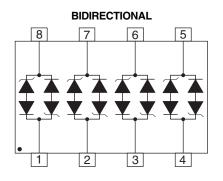
- ✓ 500 Watts Peak Pulse Power per Line (tp=8/20µs)
- ✓ Unidirectional & Bidirectional Configurations
- ✔ Available in Multiple Voltage Types Ranging From 3V to 24V
- ✔ Protects Up to Four (4) Lines
- ✓ ESD Protection > 40 kilovolts
- ✓ Low Capacitance: 15pF
- ✔ RoHS Compliant

MECHANICAL CHARACTERISTICS

- ✓ Molded JEDEC SO-8
- ✓ Weight 70 milligrams (Approximate)
- ✔ Available in Lead-Free Pure-Tin Plating(Annealed)
- ✓ Solder Reflow Temperature:
 - Pure-Tin Sn, 100: 260-270°C
- ✔ Consult Factory for Leaded Device Availability
- ✓ Flammability Rating UL 94V-0
- ✓ 12mm Tape and Reel Per EIA Standard 481
- ✓ Marking: Marking Code, Logo, Date Code & Pin One Defined By Dot on Top of Package

PIN CONFIGURATIONS







05074.R8 3/08 1 <u>www.protekdevices.com</u>

DEVICE CHARACTERISTICS

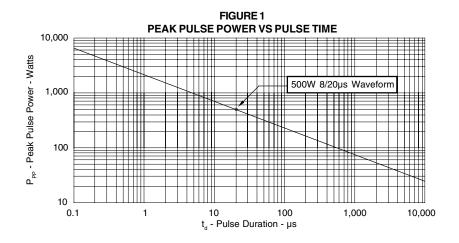
MAXIMUM RATINGS @ 25°C Unless Otherwise Specified							
PARAMETER	SYMBOL	VALUE	UNITS				
Peak Pulse Power (t _D = 8/20μs) - See Figure 1	P_{PP}	500	Watts				
Operating Temperature	T _L	-55 to 150	∞				
Storage Temperature	T _{STG}	-55 to 150	∞				
Forward Voltage @ 50mA, 300µs - Square Wave (See Note 1)	V _F	1.5	Volts				

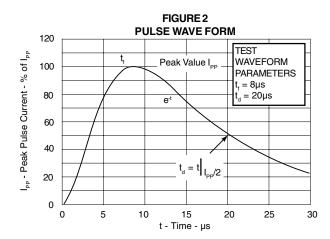
Note 1: Only applies to unidirectional devices.

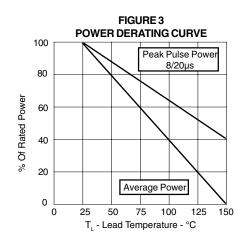
ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified									
PART NUMBER (See Notes 1)	DEVICE MARKING	RATED STAND-OFF VOLTAGE	MINIMUM BREAKDOWN VOLTAGE	MAXIMUM CLAMPING VOLTAGE (See Fig. 2)	MAXIMUM CLAMPING VOLTAGE (See Fig. 2)	MAXIMUM LEAKAGE CURRENT	MAXIMUM CAPACITANCE (See Note 2)		
		V _{wm} VOLTS	@ 1mA V _(BR) VOLTS	@ I _P = 1A V _C VOLTS	@8/20µs V _C @ I _{PP}	@ν _{wм} 	@0V, 1 MHz C pF		
SMDA03LC	SLA	3.3	4.5	7.0	10.9V @ 43.0A	125	15		
SMDA03LCC	SLB	3.3	4.5	7.0	10.9V @ 43.0A	125	15		
SMDA05LC	SLC	5.0	6.0	9.8	13.5V @ 42.0A	20	15		
SMDA05LCC	SLD	5.0	6.0	9.8	13.5V @42.0A	20	15		
SMDA08LC	SLE	8.0	8.5	13.4	16.9V @ 34.0A	10	15		
SMDA08LCC	SLF	8.0	8.5	13.4	16.9V @ 34.0A	10	15		
SMDA12LC	SLG	12.0	13.3	19.0	25.9V @ 27.0A	1	15		
SMDA12LCC	SLH	12.0	13.3	19.0	25.9V @ 27.0A	1	15		
SMDA15LC	SLJ	15.0	16.7	24.0	30.0V @ 17.0A	1	15		
SMDA15LCC	SLK	15.0	16.7	24.0	30.0V @ 17.0A	1	15		
SMDA24LC	SLL	24.0	26.7	43.0	49.0V @ 12.0A	1	15		
SMDA24LCC	SLM	24.0	26.7	43.0	49.0V @ 12.0A	1	15		

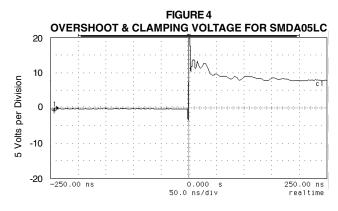
 $\textbf{Note 1:} \ \ \text{Part numbers with a "C" suffix are bidirectional devices, i.e., SMDA03L$$\underline{CC}$.$

GRAPHS









ESD Test Pulse: 5 kilovolt, 1/30ns (waveform)

SMDA03LC SMDA24LCC

APPLICATION NOTE

The SMDAxxLC & SMDAxxLCC Series are TVS arrays designed to protect I/O or data lines from the damaging effects of ESD, EFT and other types of surges. This product series provides both unidirectional and bidirectional protection, with a surge capability of 500 Watts Ppp per line for an 8/20µs waveform and ESD protection > 40kV.

UNIDIRECTIONAL COMMON-MODE CONFIGURATION(Figure 1)

The SMDAxxLC Series provides up to four (4) lines of protection in a common-mode configuration as depicted in Figure 1. Circuit connectivity is as follows:

- Line 1 is connected to Pin 5.
- Line 2 is connected to Pin 6.
- Line 3 is connected to Pin 7.
- Line 4 is connected to Pin 8.
- Pins 1-4 are connected to ground.

BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 2)

Ideal for Ethernet applications, SMDAxxLCC Series provides up to four (4) lines of protection in a common-mode configuration as depicted in Figure 2.

Circuit connectivity is as follows:

- TPIN is connected to Pin 5.
- TPIP is connected to Pin 6.
- TPON is connected to Pin 1.
- TPOP is connected to Pin 2.
- Pins 3, 4, 7 & 8 are connected to ground.

CIRCUIT BOARD LAYOUT RECOMMENDATIONS

Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- The path length between the TVS device and the protected line should be minimized.
- All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

Figure 1. Unidirectional Common-Mode Protection

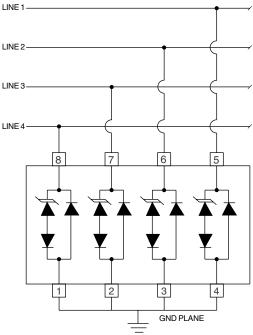
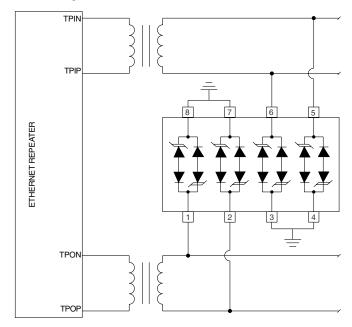
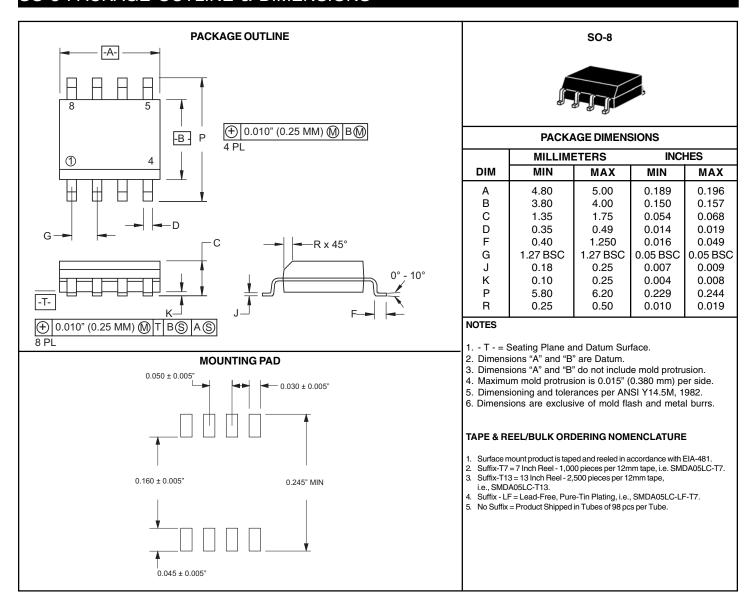


Figure 2. Bidirectional Common-Mode Protection



SMDA03LC SMDA24LCC

SO-8 PACKAGE OUTLINE & DIMENSIONS



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ProTek Devices

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